

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S30	512	(ceramic with substrate) with plat\$5 with gold	US-PGPUB; USPAT	OR	ON	2005/05/27 18:49
S32	152	S30 with nickel	US-PGPUB; USPAT	OR	ON	2005/05/27 19:38
S33	1	heat\$1sink with braz\$5 with copper with silver with alloy	US-PGPUB; USPAT	OR	ON	2005/05/27 19:40
S34	347	(257/706.ccls. 257/712.ccls. 257/720.ccls. 257/E23.141.ccls. 257/E23.174.ccls. 257/E23.169.ccls. 257/698.ccls. 257/700.ccls.) and @pd>"20050427"	US-PGPUB; USPAT	OR	ON	2005/11/10 10:09
S35	82	(heat\$1sink heat\$1slug) with (opening hole) with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/10 11:19
S36	20558	((nickel Ni) with (plated plating electroplat\$5 electroless\$4)) and ((gold Au) with (plated plating electroplat\$5 electroless\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/10 12:18
S37	1366	S36 and (substrate with (alumina aluminum\$1nitride AlN))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/10 11:24
S38	37	S37 and (substrate with (via\$1 near second))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/10 11:25
S39	0	("2005/0077609").URPN.	USPAT	OR	ON	2005/11/10 11:31
S40	1042	((nickel Ni) with (plated plating electroplat\$5 electroless\$4) with surface with substrate) and ((gold Au) with (plated plating electroplat\$5 electroless\$4) with surface with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/10 12:20
S41	1016	((nickel Ni) with (plated plating electroplat\$5 electroless\$4) with surface with substrate) same ((gold Au) with (plated plating electroplat\$5 electroless\$4) with surface with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/10 12:23

S42	4	((nickel Ni) with (plated plating electroplat\$5 electroless\$4) with surface with substrate) same ((gold Au) with (plated plating electroplat\$5 electroless\$4) with surface with substrate with (pattern adj (first second third another)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/10 12:25
S43	1	("6426290").URPN.	USPAT	OR	ON	2005/11/10 12:28
S44	1	"6426290"	DERWENT	OR	ON	2005/11/10 12:29
S45	1	(U11-C05C6 and U11-D01A3 and U11-D01A5 and V04-R02B and V04-R05B).epi.	DERWENT	OR	ON	2005/11/10 12:29
S46	1	(U11-C\$ and U11-D\$ and V04-R02B and V04-R05B).epi.	DERWENT	OR	ON	2005/11/10 12:30
S47	1	(U11-\$ and V04-R02B and V04-R05B).epi.	DERWENT	OR	ON	2005/11/10 12:30
S48	12	(V04-R02B and V04-R05B).epi.	DERWENT	OR	ON	2005/11/10 12:39
S49	10	((("4545885") or ("4595480") or ("4758927") or ("4768077") or ("4878990") or ("5468993") or ("5541477") or ("5819398") or ("6117300") or ("6348142"))).PN.	US-PGPUB; USPAT	OR	OFF	2005/11/10 12:39
S50	4	(electroplat\$5 plated plating) with selective\$2 with different with (metals materials) with (side surface) with "same"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 14:40
S51	11	("3274092" "3306830" "3582477" "3763027" "4264416").PN. OR ("4358349").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/11 14:54
S52	1	((((base substrate) with pin\$1 with (via\$1 opening\$1 hole\$1)) and ((metal near (pattern\$1 trace\$1)) with (second third another)) and (electrically near isolate)).clm.	US-PGPUB	OR	ON	2005/11/17 07:19

EAST *adm.*